



# HMC530LP5 / 530LP5E

## MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 9.5 - 10.8 GHz



### Typical Applications

Low noise MMIC VCO w/Half Frequency, Divide-by-4 Outputs for:

- Point to Point/Multipoint Radio
- Test Equipment & Industrial Controls
- SATCOM
- Military End-Use

### Features

Triple Output:  $F_o = 9.5 - 10.8$  GHz  
 $F_o/2 = 4.75 - 5.4$  GHz  
 $F_o/4 = 2.38 - 2.7$  GHz

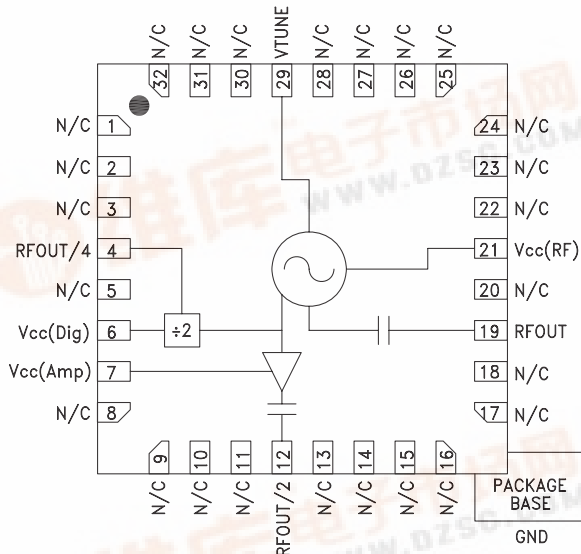
Pout: +11 dBm

Phase Noise: -110 dBc/Hz @100 kHz Typ.

No External Resonator Needed

QFN Leadless SMT Package, 25 mm<sup>2</sup>

### Functional Diagram

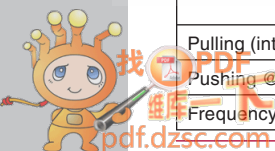


### General Description

The HMC530LP5 & HMC530LP5E are GaAs InGaP Heterojunction Bipolar Transistor (HBT) MMIC VCOs. The HMC530LP5 & HMC530LP5E integrate resonators, negative resistance devices, varactor diodes and feature half frequency and divide-by-4 outputs. The VCO's phase noise performance is excellent over temperature, shock, and process due to the oscillator's monolithic structure. Power output is +11 dBm typical from a +5V supply voltage. The prescaler and RF/2 functions can be disabled to conserve current if not required. The voltage controlled oscillator is packaged in a leadless QFN 5x5 mm surface mount package, and requires no external matching components.

### Electrical Specifications, $T_A = +25^\circ C$ , $V_{cc} (Dig)$ , $V_{cc} (Amp)$ , $V_{cc} (RF) = +5V$

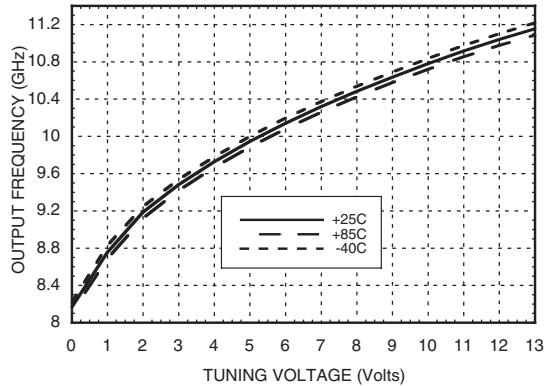
Parameter	Min.	Typ.	Max.	Units	
Frequency Range		9.5 - 10.8		GHz	
		4.75 - 5.4		GHz	
Power Output	RFOUT	+8	+14	dBm	
	RFOUT/2	+8	+14	dBm	
	RFOUT/4	-8	-3	dBm	
SSB Phase Noise @ 100 kHz Offset, $V_{tune} = +5V @ RFOUT$		-110		dBc/Hz	
Tune Voltage	$V_{tune}$	2	12	V	
Supply Current	$I_{cc}(Dig) + I_{cc}(Amp) + I_{cc}(RF)$	290	350	390	mA
Tune Port Leakage Current ( $V_{tune} = 13V$ )			10	$\mu A$	
Output Return Loss		5		dB	
Harmonics/Subharmonics	1/2	30		dBc	
	2nd	20		dBc	
	3rd	30		dBc	
Pulling (into a 2.0:1 VSWR)		7		MHz pp	
Pushing @ $V_{tune} = 5V$		20		MHz/V	
Frequency Drift Rate		1		MHz/ $^\circ C$	



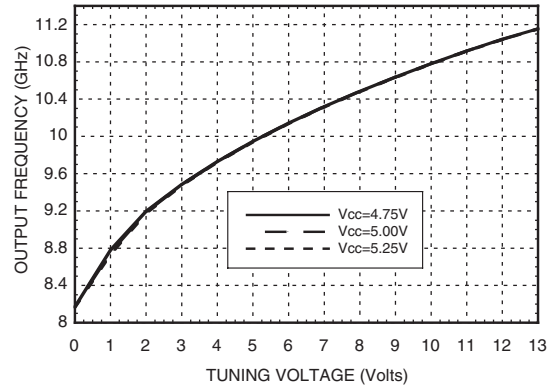
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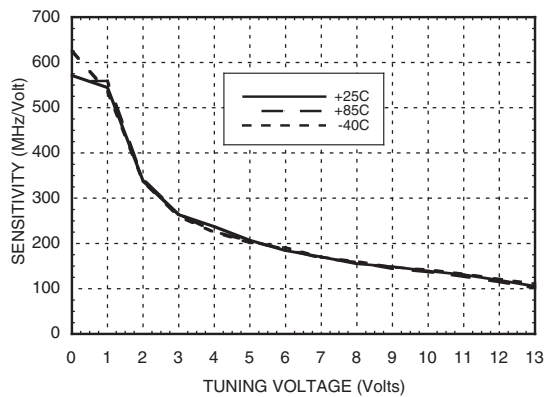
**Frequency vs. Tuning Voltage, Vcc = +5V**



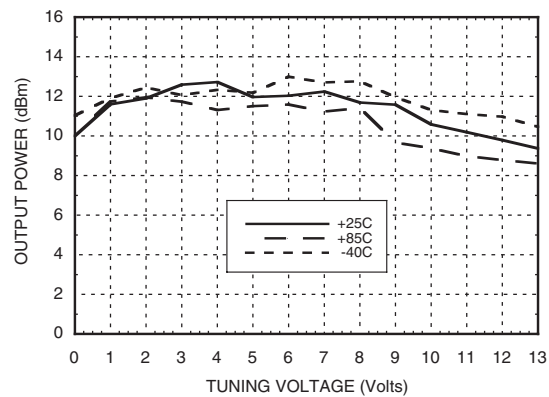
**Frequency vs. Tuning Voltage, T= 25°C**



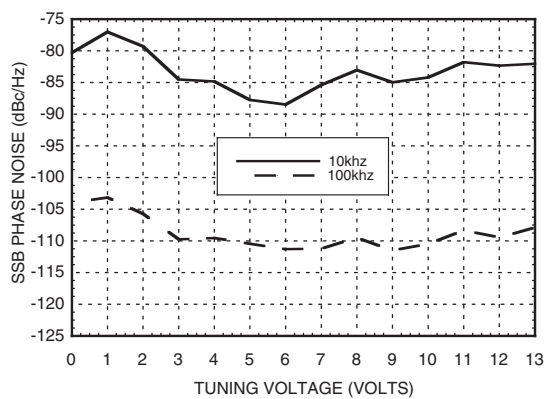
**Sensitivity vs. Tuning Voltage, Vcc = +5V**



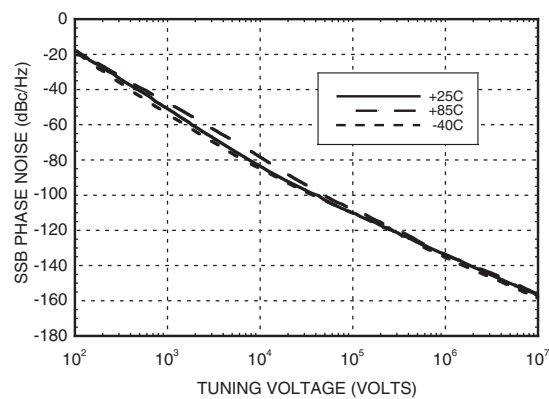
**Output Power vs. Tuning Voltage, Vcc = +5V**



**SSB Phase Noise vs. Tuning Voltage**



**SSB Phase Noise @ Vtune = +5V**

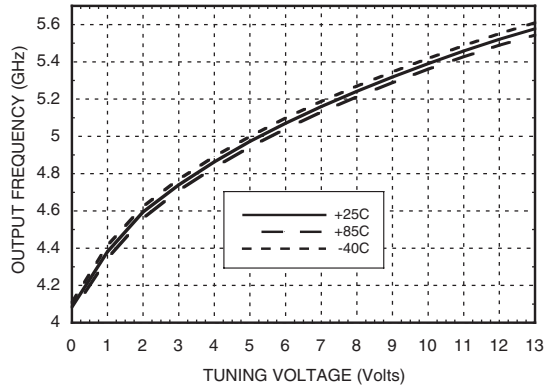




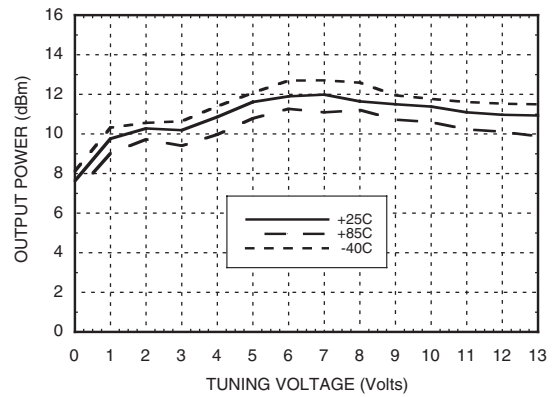
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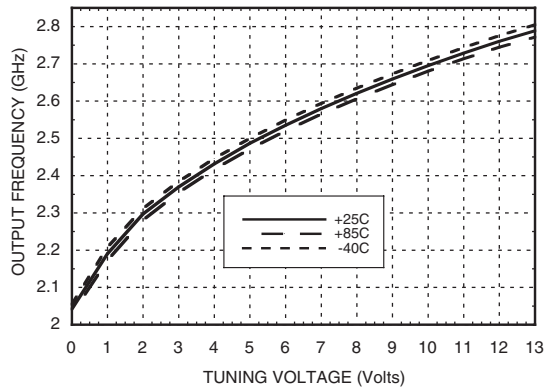
**RFOUT/2 Frequency  
vs. Tuning Voltage, Vcc = +5V**



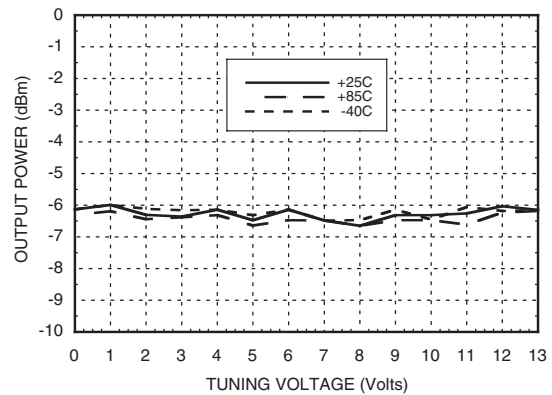
**RFOUT/2 Output Power  
vs. Tuning Voltage, Vcc = +5V**



**Divide-by-4 Frequency  
vs. Tuning Voltage, Vcc = +5V**



**Divide-by-4 Output Power  
vs. Tuning Voltage, Vcc = +5V**



## HMC530LP5 / 530LP5E

### MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 9.5 - 10.8 GHz

#### Absolute Maximum Ratings

Vcc(Dig), Vcc(Amp), Vcc(RF)	+5.5 Vdc
Vtune	0 to +15V
Junction Temperature	135 °C
Continuous Pdiss (T=85 °C) (derate 43.5 mW/C above 85 °C)	2.17 W
Thermal Resistance (junction to ground paddle)	23 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A

#### Typical Supply Current vs. Vcc

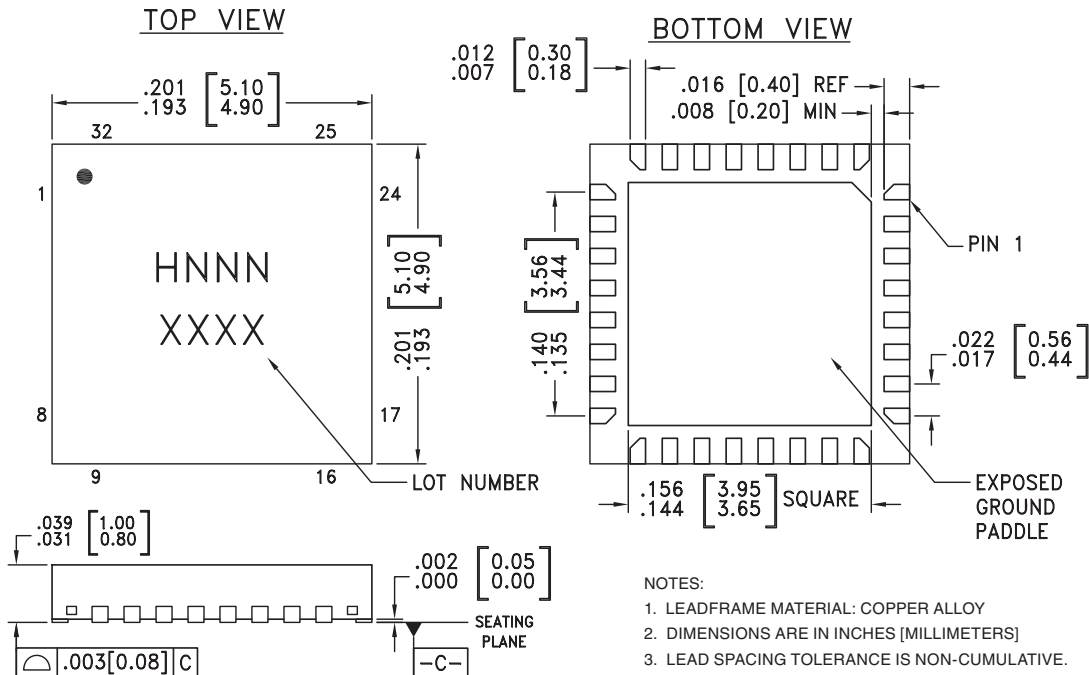
Vcc (V)	Icc (mA)
4.75	320
5.00	350
5.25	380

Note: VCO will operate over full voltage range shown above.



**ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS**

#### Outline Drawing



#### NOTES:

- LEADFRAME MATERIAL: COPPER ALLOY
- DIMENSIONS ARE IN INCHES [MILLIMETERS]
- LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.  
PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

#### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC530LP5	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 <sup>[1]</sup>	H530 XXXX
HMC530LP5E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 <sup>[2]</sup>	H530 XXXX

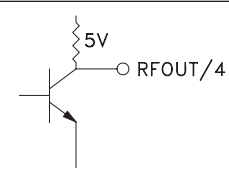
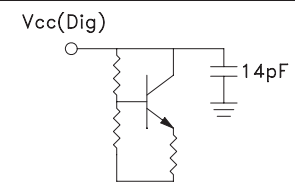
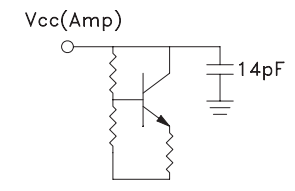
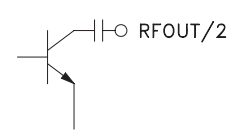
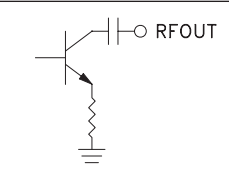
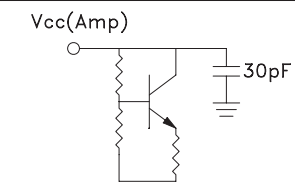
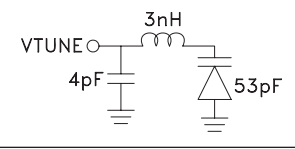

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

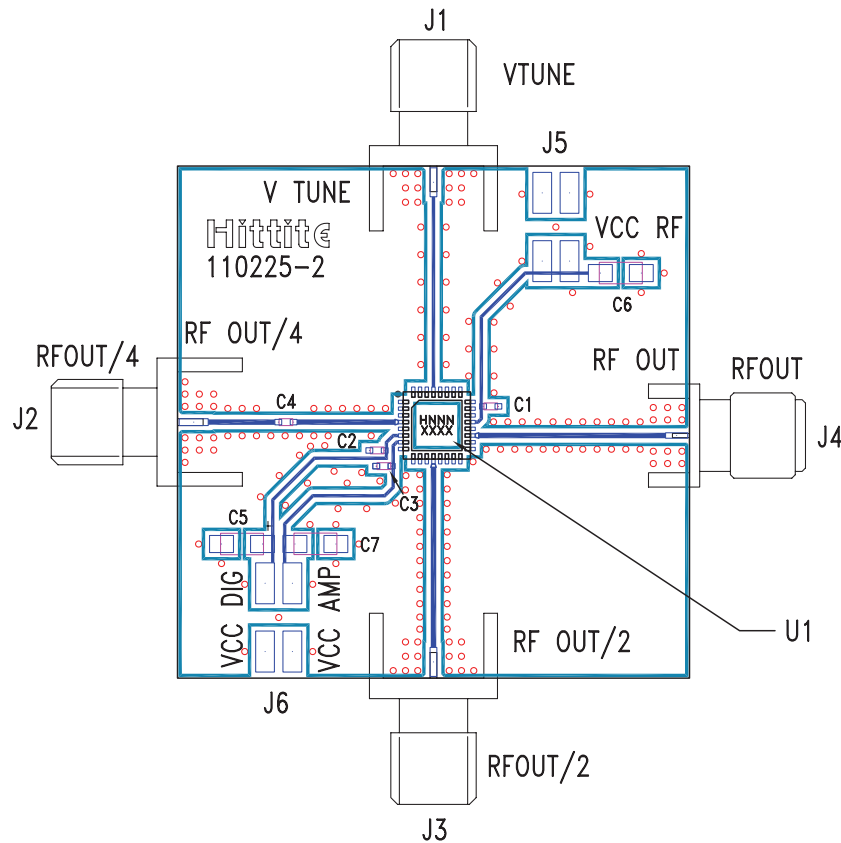
[3] 4-Digit lot number XXXX



**Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1-3, 5, 8-11, 13-18, 20, 22-28, 30-32	N/C	No Connection. These pins may be connected to RF/DC ground. Performance will not be affected.	
4	RFOUT/4	Divide-by-4 output. DC block required.	
6	Vcc (Dig)	Supply voltage for prescaler. If prescaler is not required, this pin may be left open to conserve approximately 65 mA of current.	
7	Vcc (Amp)	Supply voltage for RFOUT/2 output. If RFOUT/2 is not required, this pin may be left open to conserve approximately 30 mA of current.	
12	RFOUT/2	Half frequency output (AC coupled).	
19	RF OUT	RF output (AC coupled).	
21	Vcc (RF)	Supply Voltage, +5V	
29	VTUNE	Control voltage and modulation input. Modulation bandwidth dependent on drive source impedance. See "Determining the FM Bandwidth of a Wideband Varactor Tuned VCO" application note.	
	GND	Package bottom has an exposed metal paddle that must be connected to RF/DC ground.	

### Evaluation PCB



### List of Materials for Evaluation PCB 110227 [1]

Item	Description
J1 - J4	PCB Mount SMA RF Connector
J5 - J6	2 mm DC Header
C1 - C3	100 pF Capacitor, 0402 Pkg.
C4	1,000 pF Capacitor, 0402 Pkg.
C5 - C7	2.2 $\mu$ F Tantalum Capacitor
U1	HMC530LP5 / HMC530LP5E VCO
PCB [2]	110225 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and backside ground paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.



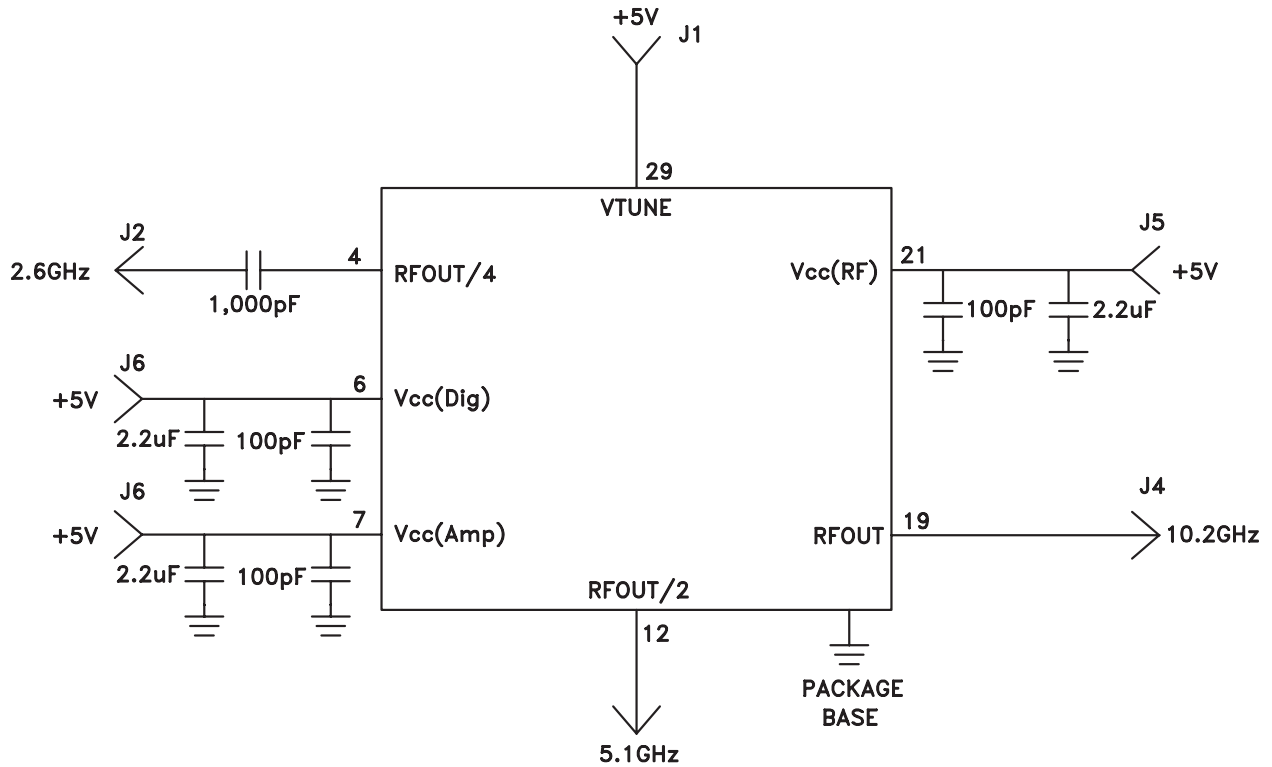
MICROWAVE CORPORATION v00.0407



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## Typical Application Circuit



10

VCOs & PLOs - SMT



v00.0407



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**Notes:**